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	S	pecification
Pai	rt Number:	MCCOG128064G6W-FPTLW
Ve	rsion:	
Da	te:	
		Revision
	11	

design • manufacture • supply

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## 2. General Specification

The Features is described as follow:

■ Module dimension: 60.1x 44.5 x5.01 (max.) mm<sup>3</sup>

View area: 54.6 x 32.0 mm<sup>2</sup>

Active area: 49.89 x27.49 mm<sup>2</sup>

■ Number of dots: 128 x 64

■ Dot size: 0.36 x0.4 mm<sup>2</sup>

■ Dot pitch: 0.39 x 0.43 mm²

■ LCD type: FSTN Positive, Transflective

■ Duty: 1/64 , 1/9 Bias

■ View direction: 6 o'clock

Backlight Type: LED, White

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### **Midas LCD Part Number System**

```
MC COG 132033
                                                  6
                                                                                     S
                                                                                                     Т
                                                                                                            L
            2
   1
                         3
                                    4
                                           5
                                                  6
                                                         7
                                                                                                    12
                                                                                                           13
                                                                8
                                                                        9
                                                                                     10
                                                                                            11
                                                                                                                   14
                                                                                                                           15
                                                                                                                                  16
                   MC: Midas Components
                   Blank: COB (chip on board)
                                                 COG: chip on glass
3
                   No of dots
                                       (e.g. 240064 = 240 x 64 dots) (e.g. 21605 = 2 x 16 5mm C.H.)
                   Series
                   Series Variant:
                                       A to Z - see addendum
5
                   3: 3 o'clock
                                       6: 6 o'clock
                                                           9: 9 o'clock
                                                                               12: 12 o'clock
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
7
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
                   ]: Asian/Arabic
                   Bezel Height (where applicable / available)
                               Top of Bezel to Top of
                                                        Common (via
                                                                        Array or
                                        PCB
                                                        pins 1 and 2)
                                                                        Edge Lit
                      Blank
                               9.5mm / not applicable
                                                          Common
                                                                         Array
                      2
                               8.9 mm
                                                          Common
                                                                         Array
                      3
                               7.8 mm
                                                          Separate
                                                                         Array
                      4
                               7.8 mm
                                                          Common
                                                                         Array
                                                                         Array
                      5
                               9.5 mm
                                                          Separate
                      6
                               7 mm
                                                          Common
                                                                         Array
                      7
8
                                                          Separate
                                                                         Array
                              7 mm
                                                          Common
                                                                         Edge
                               6.4 mm
                      9
                               6.4 mm
                                                          Separate
                                                                         Edge
                      Α
                              5.5 mm
                                                          Common
                                                                         Edge
                                                          Separate
                      В
                                                                         Edge
                               5.5 mm
                      D
                               6.0mm
                                                          Separate
                                                                         Edge
                      Е
                                                                         Edge
                                                          Separate
                               5.0mm
                      F
                               4.7mm
                                                          Common
                                                                         Edge
                      G
                              3.7mm
                                                          Separate
10
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN Z: Zero Power (Bi-Stable)
                   P: Positive N: Negative
11
                   R: Reflective M: Transmissive T: Transflective
12
                   Backlight: Blank: Reflective L: LED
13
                   Backlight Colour:
                                       Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
14
                   If Z (Zero Power):
                                       WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue
                   Driver Chip:
                                                           1: 1°C T: Toshiba T6963C A: Avant SAP1024B
                                       Blank: Standard
15
```

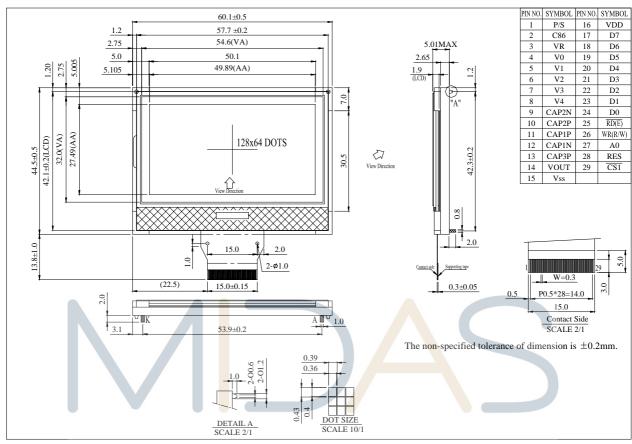
16

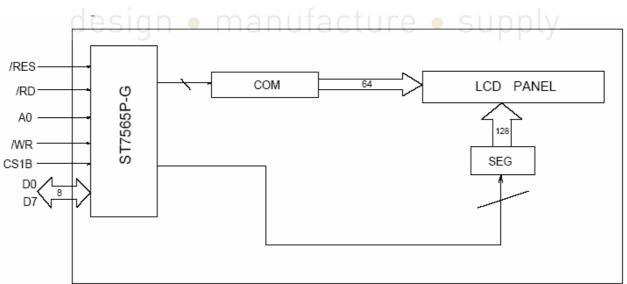
Voltage Variant: e.g. 3 = 3v

# 4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	P/S	I	This is the parallel data input/serial data input switch terminal.
2	C86	I	This is the MPU interface switch terminal.
3	VR	I	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider.
4~8	V0~V4	Power supply	This is a multi-level power supply for the liquid crystal drive.
9	CAP2N	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2P terminal.
10	CAP2P	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2N terminal.
11	CAP1P	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
12	CAP1N	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1P terminal.
13	CAP3P	0	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
14	VOUT	0	DC/DC voltage converter. Connect a capacitor between this terminal and vss or VDD
15	VSS	Power supply	Ground
16	VDD	Power supply	Power supply Supply
17~24	D7~ D0	I/O	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus.
25	/RD(E)	I	The data bus is in output status when this signal is "L"
26	/WR(R/W)	I	The data bus are latched at the rising edge of the WR signal
27	A0	I	This is connect to the least significant bit of the Norman MPU address bus, and it determines whether the data bits are data or a command.
28	/RES	1	When RES is set to "L", the setting are initialized.
29	/CS1	I	This is the chip select signal.

# 5. Outline Dimension & Block Diagram



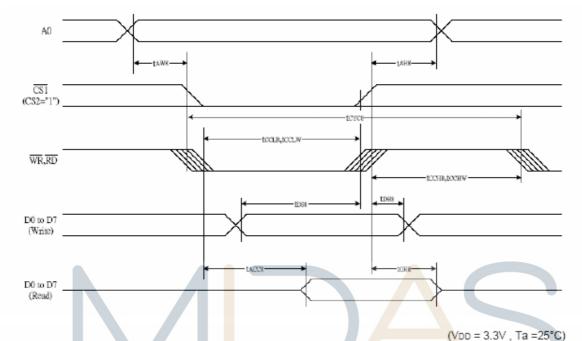


# 6. Display Command

Т				Con	nma	nd C	Corde	_				
Command	ΑĐ	/RID	WR	D7				D3	D2	D1	D0	Function
(1) Display ON/OFF	0	1	D	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	D	0	1	DI	Ispla	y sta	art a	ddre		Sets the display RAM display start line address
(3) Page address set	0	1	D	1	0	1	1	Pa	ge a	oddin	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set	0 0	1	0	0	0	0	1	colu Lea	umn sst s	add Igniff		Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of
(5) Status read	0	0	1		St	atus	;	COIL		800	ress O	the display RAM column address. Reads the status data
(6) Display data write	1	1	D			1	With	e da	ta			Writes to the display RAM
(7) Display data read	1	0	1				Rea	d da	ta			Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0	1	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	D	1	0	0	1	1	1	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	٥	1	0	1	D	1	0	0	1	٥	1	Display all points 0: normal display 1: all points ON
(11) LCD blas set	0	1	D	1	D	1	0	0	0	1	1	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565P)
(12) Read/modify/write	0	1	D	1	1	1	0	0	0	D	0	Column address increment At write: +1 At read: 0
(13) End (   C S   (	o	1	0	Πŧ	ŧ	1	þ	<u>]</u> 1(	ી	1	lo e	Clear read/modify/write
(14) Reset	0	1	D	1	1	-1	0	0	0	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	1	•	•	•	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		erai ode	ting	Select Internal power supply operating mode
(17) Vo voltage regulator internal resistor ratio set	0	1	D	0	0	1	0	0		esist stio	ar	Select Internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1	0		0 ctro	0 nic v	0 rolun	_		Set the Vo output voltage electronic volume register
(19) Static Indicator ON/OFF Static Indicator	0	1	0	1				1			1	0: OFF, 1: ON
register set				0	0	0	0	0	0	0	Mode	Set the flashing mode
(20) Booster ratio set	0	1	0	1 0	0		1 0				0 p-up ilue	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x
(21) Power saver												Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	•	•	•		Command for IC test. Do not use this command

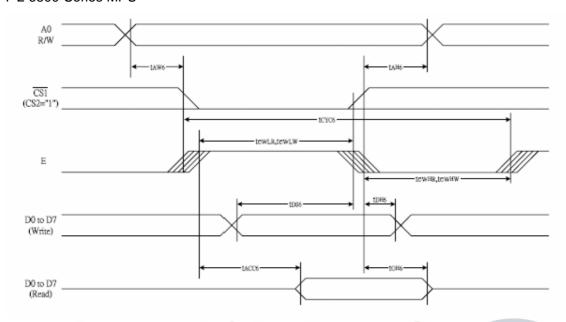
# 7. Timing Characteristics

#### 7-1 8080 Series MPU



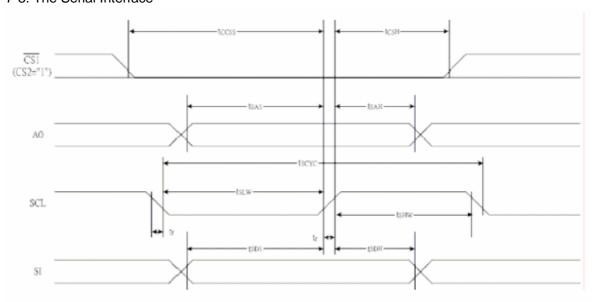
Item	Signal	Symbol	Condition	Rati	ng	Units
item	Signal	Syllibol	Condition	Min.	Max.	Ullits
Address hold time		tah8		0	_	
Address setup time	A0	taws		0	_	]
System cycle time		tcycs	facture	240	nTol	]
Enable L pulse width (WRITE)	WR	tccLw	lacture	80	ppt	У
Enable H pulse width (WRITE)	VVIC	tccнw		80	_	]
Enable L pulse width (READ)	RD	tcclr		140	_	Ns
Enable H pulse width (READ)		tcchr		80		]
WRITE Data setup time		toss		40	_	]
WRITE Address hold time	D0 to D7	tDH8		0	_	]
READ access time	1 20 10 27	taccs	CL = 100 pF	_	70	]
READ Output disable time		tонв	С∟ = 100 рГ	5	50	

#### 7-2 6800-Series MPU



(VDD = 3.3 V , Ta = 25°C ) Rating Units Item Signal Symbol Condition Min. Max. Address hold time tam6 0 Address setup time A0 taws 0 System cycle time 240 tayas Enable L pulse width (WRITE) 80 tewsw WR Enable H pulse width (WRITE) 80 tewnw Enable L pulse width (READ) tewus: 80 RD Enable H pulse width (READ) tewnr 140 WRITE Data setup time tos6 40 WRITE Address hold time ton6 0 D0 to D7 70 READ access time tacc6 CL = 100 pF READ Output disable time CL = 100 pF 5 50 toн6

### 7-3. The Serial Interface



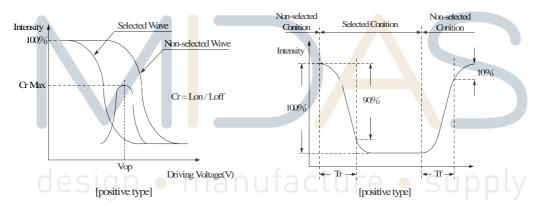
				(VDD = 3.)	3V, Ta =25°	C)
Item	Signal	Symbol	Condition	Rati	ng	Units
Item	Signal	Symbos	Condition	Min.	Max.	Ullits
Serial Clock Period		Tseyc		50	-	
SCL *H* pulse width	SCL	Tshw		25	1	
SCL "L" pulse width		Tstw		25	_	
Address setup time	4.0	Tsas		20	_	
Address hold time	A0	Tsan		10	_	ns
Data setup time	SI	Tada		20	_	
Data hold time	31	Тзрн		10	_	
CS-SCL time	Mts I	Toss   f _	cture	20_		\/
CS-SCL time	1 42	Tosh	cture	40		У

# 8. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit	
View Angle	(V)	CR 2	30	_	40	deg	
View / trigic	(H)	CR 2	-40	_	40	deg	
Contrast Ratio	CR	_	_	5	_	_	
Response Time	T rise	_	_	100	280	ms	
	T fall	_	_	150	330	ms	

### **Definition of Operation Voltage, Vop.**

#### **Definition of Response Time, Tr and Tf.**

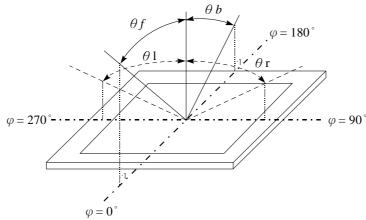


#### **Conditions:**

Operating Voltage : Vop Viewing Angle( , ) : 0°, 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

### Definition of viewing angle (CR 2)



# 9. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	
Storage Temperature	T <sub>ST</sub>	-30	_	+80	
Supply voltage for Logic	$V_{DD}$	-0.3	_	5.0	V
LCD Driver Supply Voltage	V <sub>OUT</sub> ,V0	0		18.0	V

## 10. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For	$V_{DD}$ - $V_{SS}$	_	2.7	3.0	3.3	V
Logic	V DD V 55		2.7	0.0	0.0	, ,
Supply Voltage For LCM		Ta=-20	9.43	9.73	10.03	V
*Note	V0-V <sub>SS</sub>	Ta=25	9.20	9.45	9.7	V
docian	• man	Ta=70	8.87	9.17	9.47	V
Input High Volt.	VIH	ulacti	$0.8 V_{DD}$		$V_{DD}$	-
Input Low Volt.	$V_{IL}$	_	Vss		$0.2~V_{DD}$	V
Output High Volt.	V <sub>OH</sub>	I <sub>OUT</sub> =-0.5mA	$0.8 V_{DD}$		$V_{DD}$	V
Output Low Volt.	$V_{OL}$	I <sub>OUT</sub> =0.5mA	Vss	_	0.2V <sub>DD</sub>	V
Supply Current(No						
include	$I_{DD}$	$V_{DD}=3.0V$		0.10	2.0	mA
LED Backlight)						

# 11.Backlight Information

### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	43.2	48	75	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	
Reverse Voltage	VR	_	_	5	V	_
Luminous Intensity (Without LCD)	IV	568	710	_	CD/M <sup>2</sup>	ILED=48mA
LED Life Time (For Reference only)	-1		50K		Hr.	ILED 48mA 25 ,50-60%RH, (Note 1)
Color	White		•			

Note: The LED of B/L is drive by current only; driving voltage is only for reference To make driving current in safety area (waste current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

# 12. Reliability

### Content of Reliability Test (wide temperature, -20 ~70 )

Environmental Test								
Test Item	Content of Test	Condition	Note					
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 200hrs	2					
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 200hrs	-					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20 200hrs	1					
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60 ,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20 25 70  30min 5min 30min 1 cycle	-20 /70 10 cycles	-					
desig	n • manufacture • st  Endurance test applying the vibration during transportation and using.	fixed amplitude: 15mm Vibration. Frequency: 10~55Hz. One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS= 1.5k CS=100pF 1 time						

Note1: No dew condensation to be observed.

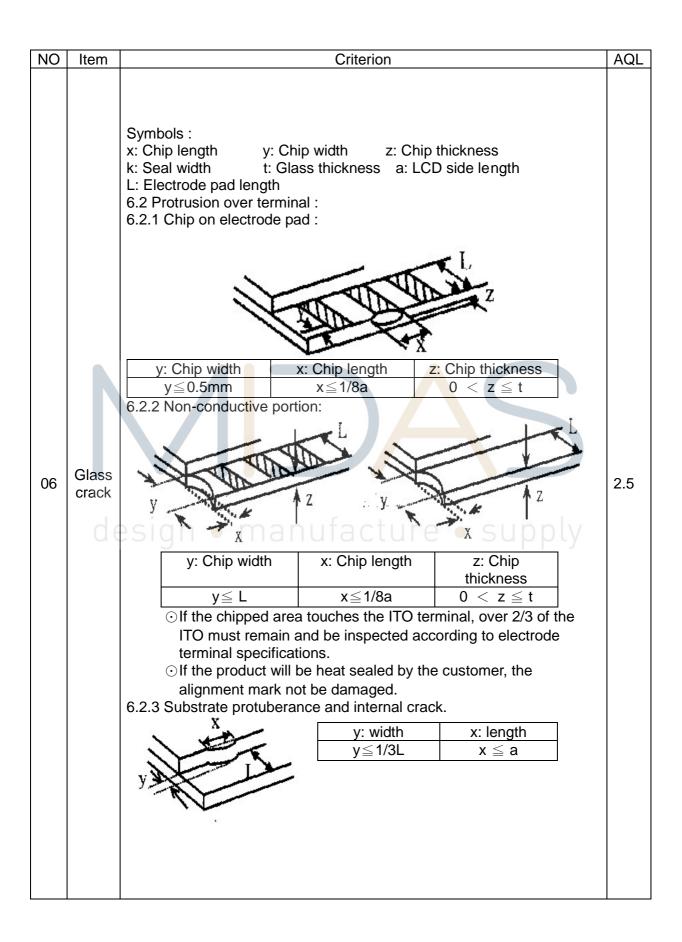
Note2: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

# 13. Inspection specification

NO	Item			Criterion		AQL		
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>						
02	Black or white spots on LCD (display only)	than three v	2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm					
03	LCD black spots, white spots, contaminatio	3.1 Round type = (x + y) /	72	wing drawing  Cture	supply	2.5		
	n (non-display)	3.2 Line type :	(As follow Length $$ $L \le 3.0$ $L \le 2.5$ $$	ing drawing)  Width  W≦0.02  0.02 < W≦0.03  0.03 < W≦0.05  0.05 < W	Acceptable Q TY Accept no dense 2 As round type	2.5		
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size  ≤0.20  0.20 < ≤0.50  0.50 < ≤1.00  1.00 <  Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5		

NO	Item	Criterion	AQL		
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination			
06	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    z: Chip thickness   y: Chip width   x: Chip length     Z ≤ 1/2t   Not over viewing   x ≤ 1/8a     1/2t < z ≤ 2t   Not exceed 1/3k   x ≤ 1/8a     o  If there are 2 or more chips, x is total length of each chip.    z: Chip thickness   y: Chip width   x: Chip length     c  Corner crack:    z: Chip thickness   y: Chip width   x: Chip length     z ≤ 1/2t   Not over viewing   x ≤ 1/8a     area   1/2t < z ≤ 2t   Not exceed 1/3k   x ≤ 1/8a     o  If there are 2 or more chips, x is the total length of each chip.	2.5		



NO	Item	Criterion	AQL			
07	Cracked glass	The LCD with extensive crack is not acceptable.				
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>				
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>				
10	PCB · COB design	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul> X * Y<=2mm²	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5			
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65			

NO	Item Criterion		
NO 12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 LCD pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65
	N	packaging specification sheet.  12.11 Product dimension and structure must conform to product specification sheet.	0.65

# 14. Precautions in use of LCD Modules

- 1. Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- 2. Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- 3. Don't disassemble the LCM.
- 4. Don't operate it above the absolute maximum rating.
- 5. Don't drop, bend or twist LCM.
- 6. Soldering: only to the I/O terminals.
- 7. Storage: please storage in anti-static electricity container and clean environment.

### 15. Material List of Components for RoHs

1. A aæ hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs		
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm		
Above limited value is set up according to RoHS.								

- 2. Process for RoHS requirement:
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow: 250, 30 seconds Max.;

Connector soldering wave or hand soldering: 320, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5

Recommended customer's soldering temp. of connector: 280, 3 seconds.